

# **Excellent Integrated System Limited**

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STMicroelectronics STPS30120DJF-TR

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# STPS30120DJF

# Power Schottky rectifier

### **Features**

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low forward voltage drop
- Low thermal resistance
- High avalanche capability specified
- ECOPACK<sup>®</sup>2 compliant component

## Description

Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in PowerFLAT<sup>™</sup>, this device is intended for use in low voltage, high frequency inverters, free-wheeling and polarity protection applications.

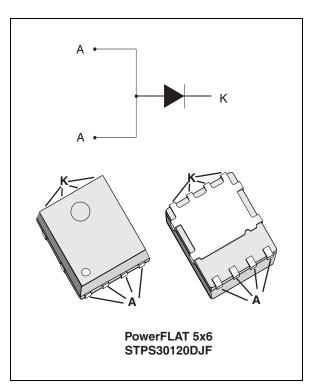


Table 1.	Device summary
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Symbol	Value
I <sub>F(AV)</sub>	30 A
V <sub>RRM</sub>	120 V
T <sub>j</sub> (max)	150 °C
V <sub>F</sub> (typ)	0.61 V

TM: PowerFLAT is a trademark of STMicroelectronics



### Characteristics

## **1** Characteristics

#### Table 2. Absolute Ratings (limiting values, anode terminals short circuited)

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage		120	V
I <sub>F(RMS)</sub>	Forward rms current		45	А
I <sub>F(AV)</sub>	Average forward current $T_c = 80 \text{ °C}, \delta = 0.5$		30	А
I <sub>FSM</sub>	Surge non repetitive forward current t <sub>p</sub> = 10 ms sinusoidal		200	А
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 1 \ \mu s \ T_j = 25 \ ^{\circ}C$		12500	W
T <sub>stg</sub>	Storage temperature range		-65 to + 175	°C
Тj	Maximum operating junction temperature (1)		150	°C

1.  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

#### Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	2.5	°C/W

### Table 4. Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
L (1)		T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>			35	μΑ
'R`		T <sub>j</sub> = 125 °C			5.5	16	mA
	. <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 15 A			0.84	
V <sub>E</sub> <sup>(1)</sup>		T <sub>j</sub> = 125 °C			0.61	0.67	v
VE TOWARD VOILage Crop	T <sub>j</sub> = 25 °C				0.92	v	
	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 30 A		0.68	0.75		

1. Pulse test: tp = 380  $\mu$ s,  $\delta$  < 2%

To evaluate the conduction losses use the following equation: P = 0.61 x  $I_{F(AV)}$  + 0.005  $I_{F}^{2}(BMS)$ 



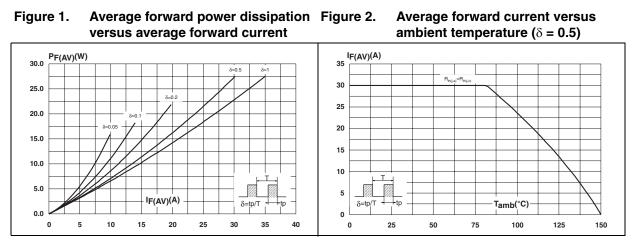


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### STPS30120DJF

#### Characteristics



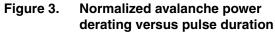


Figure 4. Normalized avalanche power derating versus junction temperature

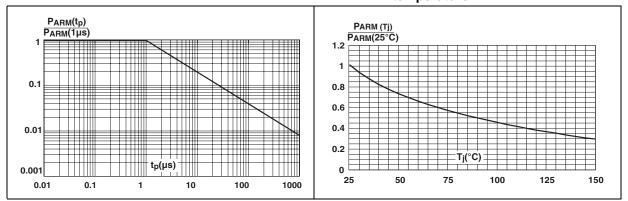
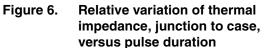
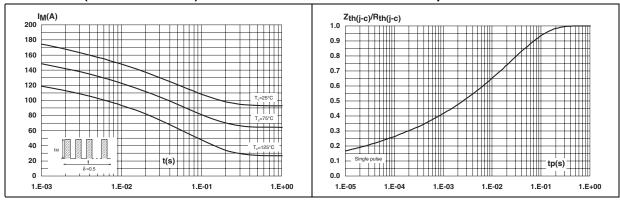
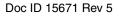


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)









### Characteristics

STPS30120DJF

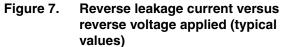


Figure 8. Junction capacitance versus reverse voltage applied (typical values)

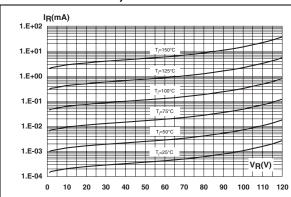


Figure 9. Forward voltage drop versus forward current

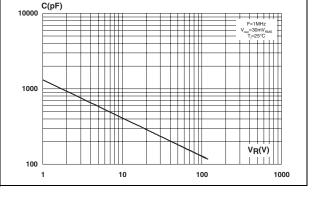
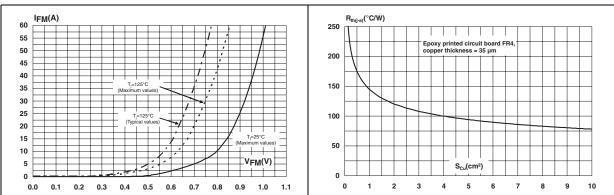


Figure 10. Thermal resistance junction to ambient versus copper surface under tab





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### STPS30120DJF

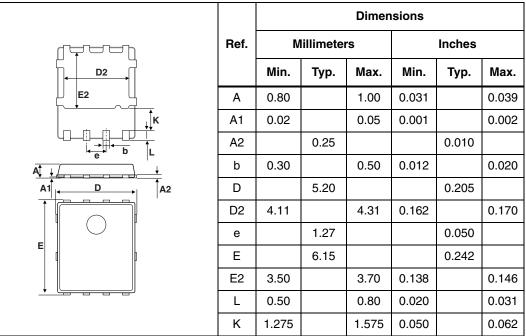
**Package information** 

# 2 Package information

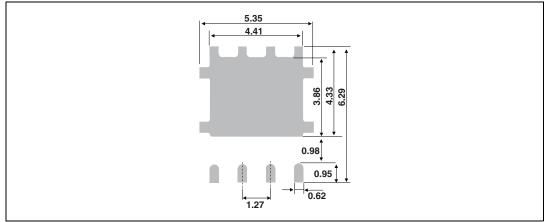
- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 5.PowerFLAT 5x6 dimensions



### Figure 11. Footprint (dimensions in mm)



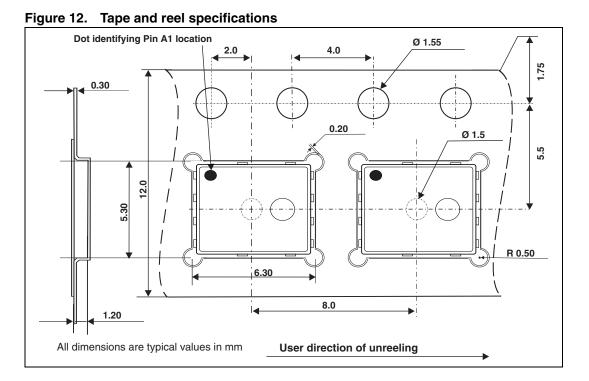




### **Ordering Information**

#### STPS30120DJF

57



# **3** Ordering Information

#### Table 6. Ordering information

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Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30120DJF-TR	PS30 120	PowerFLAT 5x6	0.095 g	3000	Tape and reel

# 4 Revision history

Table 7.	Document	revision	history
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Date	Revision	Changes
18-May-2009	1	First issue.
09-Nov-2009	2	Updated Table 1.
25-Feb-2010	3	Corrected order code and marking in <i>Table 6</i> .
30-Jul-2010	4	Replace Power QFN with PowerFLAT.
20-May-2011	5	Updated package graphics. Added mention of terminals to captions of <i>Table 2</i> and <i>Table 4</i> . Updated base quantity and marking in <i>Table 6</i> . Added <i>Figure 12</i> .





#### STPS30120DJF

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